Fourth Quarter FY 2016
Quarterly Update
Infineon Technologies AG
Investor Relations
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1. Infineon at a Glance
2. Growth Drivers
3. Results and Outlook
Infineon at a glance

Business Segments

- Automotive (ATV) 41%
- Industrial Power Control (IPC) 17%
- Power Management & Multi-market (PMM) 32%
- Chip Card & Security (CCS) 10%

Revenue in Q4 FY16: €1,675m incl. OOS & C&E of -€2m

Power represents ~60% of revenue

- ATV: 690 [EUR m]
- IPC: 279 [EUR m]
- PMM: 535 [EUR m]
- CCS: 173 [EUR m]

*embedded control, RF, sensors

Financials

<table>
<thead>
<tr>
<th>[EUR m]</th>
<th>Revenue</th>
<th>Segment Result</th>
<th>Margin</th>
</tr>
</thead>
<tbody>
<tr>
<td>FY13</td>
<td>3,843</td>
<td>377</td>
<td>9.8%</td>
</tr>
<tr>
<td></td>
<td>14.4%</td>
<td>620</td>
<td>14.4%</td>
</tr>
<tr>
<td>FY14</td>
<td>4,320</td>
<td>897</td>
<td>15.5%</td>
</tr>
<tr>
<td></td>
<td>15.2%</td>
<td>982</td>
<td>15.2%</td>
</tr>
<tr>
<td>FY15</td>
<td>5,795</td>
<td></td>
<td></td>
</tr>
<tr>
<td>FY16</td>
<td>6,473</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Market Position

- Automotive: #2
  - Strategy Analytics, April 2016
- Power: #1
  - IHS Markit, October 2016
- Smart card ICs: #2
  - IHS Markit, July 2016

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Technology leadership and system understanding fosters growth and profitability

**Competitive advantages**

**Auto**
- System leader in automotive

**Power**
- #1, system and technology leader

**RF**
- Broadest technology portfolio; #1 in SiGe; become #1 in base stations with 5G

**Security**
- Leader in security solutions

**Average-cycle financial targets**

**Revenue Growth:**
\(~8\%~)

**Segment Result Margin:**
\(~17\%~)

**Investment-to-Sales:**
\(~13\%~)

(Capex* : ~11%; capital. R&D*: ~2%)

* Infineon reports under IRFS
Our promise to investors (I):
Continued value creation through growth

Q4 FY16 y-y revenue growth exceeds market by 2%-points

[EUR m]

<table>
<thead>
<tr>
<th>Quarter</th>
<th>Revenue</th>
<th>Segment Result</th>
<th>Total semiconductor market*</th>
</tr>
</thead>
<tbody>
<tr>
<td>Q4</td>
<td>1,598</td>
<td>18%</td>
<td>18%</td>
</tr>
<tr>
<td>Q1 FY16</td>
<td>1,556</td>
<td>14%</td>
<td>14%</td>
</tr>
<tr>
<td>Q2</td>
<td>1,611</td>
<td>14%</td>
<td>14%</td>
</tr>
<tr>
<td>Q3</td>
<td>1,632</td>
<td>16%</td>
<td>16%</td>
</tr>
<tr>
<td>Q4</td>
<td>1,675</td>
<td>17%</td>
<td>17%</td>
</tr>
</tbody>
</table>

[EUR bn]

<table>
<thead>
<tr>
<th>Quarter</th>
<th>Revenue</th>
<th>Segment Result Margin</th>
</tr>
</thead>
<tbody>
<tr>
<td>Q4</td>
<td>79.1</td>
<td></td>
</tr>
</tbody>
</table>

* Source: WSTS Monthly Bluebook, October 2016

Earnings-per-share (EPS) growth

[EUR cent]

<table>
<thead>
<tr>
<th>Quarter</th>
<th>EPS basic</th>
<th>EPS adjusted</th>
</tr>
</thead>
<tbody>
<tr>
<td>Q4</td>
<td>29</td>
<td>16</td>
</tr>
<tr>
<td>Q1 FY16</td>
<td>14</td>
<td>17</td>
</tr>
<tr>
<td>Q2</td>
<td>16</td>
<td>18</td>
</tr>
<tr>
<td>Q3</td>
<td>16</td>
<td>19</td>
</tr>
<tr>
<td>Q4</td>
<td>20</td>
<td>21</td>
</tr>
</tbody>
</table>

-31% to +31%

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Our promise to investors (II):
Continued value creation through growth

RoCE as key value metric

WACC: low teens %

RoCE impacted by acquisition of International Rectifier

Total cash return to shareholders

- Policy of sustainable dividend payout.
- Increase of dividend from €0.20 to €0.22*.
- Payout of €248m*.

* Proposal to the AGM to be held on 16 Feb 2017.
Infineon increased relative market share in power and outperformed chip card market

**Automotive semiconductors**
total market in 2015: $27.4bn

- NXP: 14.2%
- Infineon: 10.4%
- Renesas: 10.3%
- STMicro: 7.7%
- Texas Instr.: 7.0%

Source: Strategy Analytics, April 2016

**Power discretes and modules**
total market in 2015: $14.8bn

- Infineon: 18.7%
- Mitsubishi: 6.3%
- Fairchild: 6.1%
- STMicro: 5.7%
- Vishay: 5.0%

Source: IHS Markit, October 2016

**Smart Card ICs**
total market in 2015: $2.72bn

- NXP: 30.5%
- Infineon: 24.8%
- Samsung: 16.2%
- STMicro: 15.1%
- CEC Huada*: 10.4%

Source: IHS Markit, July 2016

* including SHHIC (in 2015, SHHIC was acquired by CEC Huada.)
Tight customer relationships are based on system know-how and app understanding.
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Infineon benefits from industrial, auto and security, the by far fastest growing segments

CAGR 2015 – 2020 by Semiconductor Industry Segment

- Industrial: 8.2% ($42bn*)
- Chip Card ICs**: 7.3% ($3.7bn*)
- Automotive: 5.8% ($29bn*)
- Consumer: 3.4% ($45bn*)
- Total Semi Market: 3.4% ($347bn*)
- Data Processing: 2.8% ($108bn*)
- Communications: 1.4% ($123bn*)

* In calendar year 2015
** Source: ABI Research, “Secure Smart Card & Embedded Security IC Technologies”, September 2016; microcontroller ICs
Infineon is system leader in automotive; making cars clean, safe and smart

#2 with market share gains in power and sensors:
› #1 in power semiconductors**
› #2 in sensors**
› #3 in microcontrollers** (#1 in powertrain***)

Most balanced portfolio with sensors, microcontrollers and power for system approach

Leader in electric drivetrain and CO₂ reduction
- making cars clean

Leader in ADAS
- making autonomous driving safe and reliable

Leading product portfolio of sensors and security ICs for individual convenience and connectivity
- making cars smart

Focus on sustainable high-bill-of-material areas: powertrain, safety/ADAS/autonomous cars, body

Infineon is ideally positioned to benefit from ADAS*/AD*, xEV, connected cars and to gain further market share in Automotive

* See glossary; ** Source: Strategy Analytics, April 2016; *** own estimate.
Reference to web presentations

For full automotive story please refer to

a.) Update on ATV Presentation on 02 Aug 2016:
   [www.infineon.com/auto-slides](http://www.infineon.com/auto-slides)

b.) ATV Division Call by Peter Schiefer on 11 Oct 2016:
   [www.infineon.com/atv-call](http://www.infineon.com/atv-call)
Infineon is system leader with most balanced portfolio in the market

Infineon covers the entire control loop in powertrain, safety/ADAS, and comfort/body

Infineon goes beyond radar and camera targeting mass-deployable lidar systems

The first lidar systems introduced in premium cars within the next couple of years are based on mechanical scanning mirrors which are bulky and less robust.

In order to enter the car mass market lidar must get rid of mechanical parts.

MEMS-based lidar systems are
- more compact
- more cost-effective
- more robust

Innoluce’s key competence
- Power supply / Power management
- Mirror control ASIC
- System ASIC
- μC
- Amplifier
- Laser source
- MEMS-based mirror
- Detector diodes

Infineon’s key competence

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ADAS*/AD*, clean cars, and adoption of premium features drive growth

<table>
<thead>
<tr>
<th>Vehicle production</th>
<th>Drivers for semiconductor content per car</th>
</tr>
</thead>
<tbody>
<tr>
<td>~2% growth p.a.</td>
<td>Clean cars</td>
</tr>
<tr>
<td></td>
<td>› Driven by legislation</td>
</tr>
<tr>
<td></td>
<td>› Improvements of ICE* (e.g. EPS*)</td>
</tr>
<tr>
<td></td>
<td>› Adoption of xEV*</td>
</tr>
<tr>
<td></td>
<td>› Higher efficiency of all electric consumers</td>
</tr>
<tr>
<td></td>
<td>ADAS*/AD*</td>
</tr>
<tr>
<td></td>
<td>› Today:</td>
</tr>
<tr>
<td></td>
<td>› crash avoidance</td>
</tr>
<tr>
<td></td>
<td>› ADAS*</td>
</tr>
<tr>
<td></td>
<td>› Tomorrow:</td>
</tr>
<tr>
<td></td>
<td>› AD*</td>
</tr>
<tr>
<td></td>
<td>Comfort, premium</td>
</tr>
<tr>
<td></td>
<td>› Premium cars are early adopters of high-end comfort and safety features</td>
</tr>
<tr>
<td></td>
<td>› Trickling down to mid-range</td>
</tr>
</tbody>
</table>

~8% p.a. through-cycle growth

* See glossary
Infineon is #1 and technology leader in power semiconductors

- #1 in the market*
- Broaderest product and technology portfolio
- Addressing broadest range of applications
- 300 mm thin-wafer manufacturing for power semiconductors
- System leader with digitalization of the control loop and functional integration
- Leader in next-generation power semiconductor materials GaN and SiC

As system leader in power, Infineon has broadest application and technology reach.

Covering the entire power chain:

**Generation**
- Wind turbines
- Solar panels

**Transmission**
- Power lines
- Water towers

**Consumption**
- Washing machines
- Tractors
- Batteries
- Robotics
- Fans

**Main IPC markets**

**Main PMM power markets**

System competence for highest reliability and highest efficiency:

- Stacks
- Modules
- MOSFETs/IGBTs
- Drivers
- Controllers

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Infineon further strengthened its market positions

**IGBT components**
(discretes and modules)

<table>
<thead>
<tr>
<th>Brand</th>
<th>Market Share</th>
</tr>
</thead>
<tbody>
<tr>
<td>Infineon</td>
<td>27.6%</td>
</tr>
<tr>
<td>Mitsubishi</td>
<td>20.6%</td>
</tr>
<tr>
<td>Fuji Electric</td>
<td>12.5%</td>
</tr>
<tr>
<td>Semikron</td>
<td>7.6%</td>
</tr>
<tr>
<td>Fairchild</td>
<td>4.9%</td>
</tr>
</tbody>
</table>

*total market in 2015: $3.94bn

**therein: IPMs**

<table>
<thead>
<tr>
<th>Brand</th>
<th>Market Share</th>
</tr>
</thead>
<tbody>
<tr>
<td>Mitsubishi</td>
<td>45.0%</td>
</tr>
<tr>
<td>Semikron</td>
<td>11.2%</td>
</tr>
<tr>
<td>Fuji Electric</td>
<td>10.1%</td>
</tr>
<tr>
<td>Infineon</td>
<td>9.1%</td>
</tr>
<tr>
<td>ON Semi</td>
<td>8.6%</td>
</tr>
</tbody>
</table>

*total market in 2015: $1.10bn

**Discrete standard MOSFETs**

<table>
<thead>
<tr>
<th>Brand</th>
<th>Market Share</th>
</tr>
</thead>
<tbody>
<tr>
<td>Infineon</td>
<td>26.4%</td>
</tr>
<tr>
<td>Fairchild</td>
<td>9.5%</td>
</tr>
<tr>
<td>Renesas</td>
<td>8.9%</td>
</tr>
<tr>
<td>STMicro</td>
<td>8.0%</td>
</tr>
<tr>
<td>Toshiba</td>
<td>7.3%</td>
</tr>
</tbody>
</table>

*total market in 2015: $5.48bn

---

*The market for IGBT components ($3,944m) includes discrete IGBTs ($853m), Standard IGBT modules ($1,692m), CIB/PIM ($299m), and IPMs ($1,101m).

**relative market share**

Infineon continuously improved relative market share in power

Relative market share* of 3 in the total power semiconductor market

* The relative market share is defined as the proportion of the market share held by the market leader (in all years presented for Infineon) compared to the market share of the second largest competitor in the relevant year.

Source: IHS Markit, several reports from 2004 through 2016
Strong #1 position in power allows driving of key areas of differentiation and innovation

- Unique 300 mm thin wafer power semiconductor manufacturing
- Compound semiconductors SiC and GaN
- Digitalization of the power control loop
- Functional integration of IGBT modules
Efficiency and digitalization are main market drivers for power applications

<table>
<thead>
<tr>
<th>IPC</th>
<th>PMM</th>
</tr>
</thead>
<tbody>
<tr>
<td>Drives</td>
<td>AC-DC</td>
</tr>
<tr>
<td>Renewables</td>
<td>DC-DC</td>
</tr>
<tr>
<td>Traction</td>
<td></td>
</tr>
<tr>
<td>MHA</td>
<td></td>
</tr>
</tbody>
</table>

- Energy efficiency
- Automation
- Productivity increase
- Legislation
- Growing share of renewable energies as part of the energy generation mix
- Growing population in metropolitan areas
- Fast and efficient mass transport system
- Energy efficiency
- Growing VSD penetration
- Energy efficiency
- Charging time
- Compactness (power density)
- DPM
- Energy efficiency
- Compactness (power density)
- DPM
- Brushless DC motors

DPM = Digital Power Management
MHA = Major Home Appliances
VSD = Variable Speed Drive
Infineon is the leader in security solutions for the connected world

#2 in microcontroller-based smart card ICs*

#1 in embedded digital security**

Complete portfolio of hardware, software, services and turn-key solutions

Leading in growth segments payment, government ID, connected car security, IoT, and Information and Communications Technology security

Infineon is ideally positioned to benefit from the growth trends in the security controller market

* Source: IHS Markit, July 2016
** Source: IHS Markit, December 2015
CCS is enabling security for the connected world

**Smart card applications**
- Smart card payment
- Electronic passports and ID documents
- Mobile communication
- Transport ticketing

**Embedded security applications**
- Mobile device security and payment
- Information and Communications Technology security
- Industrial and automotive security
- IoT connected device security

Infineon holds leading positions in security solutions markets

- **#2**
  - Microcontroller-based smart card ICs
  - Market size: $2.72bn

- **#1**
  - Embedded secure microcontrollers
  - Market size: $698m

Source: IHS Markit, Dec 2015, July 2016; * based on units; USD-ranking not provided
Infineon’s long-term growth is based on sustainable growth drivers.

<table>
<thead>
<tr>
<th>ATV</th>
<th>IPC</th>
<th>PMM</th>
<th>CCS</th>
</tr>
</thead>
<tbody>
<tr>
<td>CO₂ reduction</td>
<td>Energy efficiency</td>
<td>Energy efficiency</td>
<td>Security as a function</td>
</tr>
<tr>
<td>Advanced Driver</td>
<td>Automation</td>
<td>Power density</td>
<td>Mobile payments</td>
</tr>
<tr>
<td>Assistance Systems</td>
<td>Productivity increase</td>
<td>BLDC motors</td>
<td>Authentication</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Mobile device and LTE growth</td>
<td>Internet of Things</td>
</tr>
</tbody>
</table>

~8% p.a. through-cycle growth

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1. Infineon at a Glance
2. Growth Drivers
3. Results and Outlook
Strong growth in ATV due to ADAS and electro-mobility

<table>
<thead>
<tr>
<th>ATV*</th>
<th>IPC*</th>
<th>PMM*</th>
<th>CCS*</th>
</tr>
</thead>
<tbody>
<tr>
<td>[EUR m]</td>
<td>[EUR m]</td>
<td>[EUR m]</td>
<td>[EUR m]</td>
</tr>
<tr>
<td>613 614 670 676 690</td>
<td>271 249 265 280 279</td>
<td>535 510 496 509 535</td>
<td>181 173 180 172 173</td>
</tr>
<tr>
<td>+13%</td>
<td>+3%</td>
<td>0%</td>
<td>-4%</td>
</tr>
<tr>
<td>17% 13% 14% 15% 17%</td>
<td>14% 9% 10% 15% 13%</td>
<td>21% 15% 15% 16% 18%</td>
<td>21% 20% 20% 19% 19%</td>
</tr>
<tr>
<td>102 81 94 104 118</td>
<td>39 23 26 42 36</td>
<td>110 79 74 79 95</td>
<td>38 35 36 32 33</td>
</tr>
<tr>
<td>Q4 FY16</td>
<td>Q4 FY16</td>
<td>Q4 FY16</td>
<td>Q4 FY16</td>
</tr>
</tbody>
</table>

* The business with XMC industrial microcontrollers developed by ATV and CCS was transferred to PMM and IPC with effect from 1 October 2015. The previous year’s figures have been adjusted accordingly.
## Guidance for Q1 FY17 and FY17

<table>
<thead>
<tr>
<th></th>
<th>Outlook Q1 FY17* (compared to Q4 FY16)</th>
<th>Outlook FY17* (compared to FY16)</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Revenue</strong></td>
<td>Decrease of 4% +/- 2%-points</td>
<td>Increase of 6% +/- 2% -points</td>
</tr>
<tr>
<td><strong>Segment Result</strong></td>
<td>At the mid-point of the revenue guidance: 14%</td>
<td>At the mid-point of the revenue guidance: 16%</td>
</tr>
<tr>
<td><strong>Margin</strong></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>Investments in FY17</strong></td>
<td>About €950m**</td>
<td></td>
</tr>
<tr>
<td><strong>D&amp;A in FY17</strong></td>
<td>About €830m***</td>
<td></td>
</tr>
</tbody>
</table>

* Based on an assumed average exchange rate of $1.10 for €1.00.
** Including approximately €35m for a new building at Infineon’s headquarters in Neubiberg near Munich.
*** Including D&A on tangible and intangible assets from purchase price allocation of International Rectifier.
Part of your life. Part of tomorrow.
Solid Investment Grade rating assigned by S&P in connection with revised capital structure targets

### Revised capital structure targets announced by Infineon in February 2016:

<table>
<thead>
<tr>
<th>a.) Gross Cash</th>
<th>b.) Gross Debt</th>
</tr>
</thead>
<tbody>
<tr>
<td>＿“€1bn plus 10% to 20% of revenue” ＿</td>
<td>＿“less than 2.0x EBITDA” ＿</td>
</tr>
</tbody>
</table>

Infineon’s revised capital structure targets are reflected in the Corporate Credit Rating of **BBB** (outlook: “stable”) assigned by S&P in February 2016.

› Rating not changed after announcement of planned Wolfspeed acquisition
Infineon has a well balanced maturity profile

Note: Other debt with maturities between 2017 and 2023 totaling €145m.
SG&A still includes noticeable acquisition-related costs that are incrementally declining.

* Target range for SG&A: “Low teens percentage of sales”.
** Target range for R&D: “Low to mid teens percentage of sales”.

![Graph showing SG&A and R&D expenses over Q4 FY16 to Q4 FY16](image)
Working capital slightly improved due to increasing liabilities

* For definition please see page 35.
Investments on target of ~13% of sales; D&A about stable in absolute terms.

* For definition please see page 35.
**The figure includes approximately €35m for a new building at Infineon’s headquarters. Excluding this amount the percentage rate is approximately 13%.
Free Cash Flow from continuing operations was €169m.

Debt decreased by €15m due to repayment of €5m long-term debt and change in FX-rates used for valuing US$-based debt.
Notes

**Investments** =

'Purchase of property, plant and equipment'
+ 'Purchase of intangible assets and other assets' * incl. capitalization of R&D expenses

**Capital Employed** =

'Total assets'
- 'Cash and cash equivalents'
- 'Financial investments'
- 'Assets classified as held for sale'
- ('Total Current liabilities'
  - 'Short-term debt and current maturities of long-term debt'
  - 'Liabilities classified as held for sale')

**RoCE** =

NOPAT / Capital Employed =

('Income from continuing operations'
 - 'financial income'
 - 'financial expense')
/ Capital Employed

**Working Capital** =

('Total current assets'
 - 'Cash and cash equivalents'
 - 'Financial investment'
 - 'Assets classified as held for sale')
- ('Total current liabilities'
  - 'Short term debt and current maturities of long-term debt'
  - 'Liabilities classified as held for sale')

**DOI** (days of inventory; quarter-to-date) =

('Net Inventories' / 'Cost of goods sold') * 90

**DPO** (days payables outstanding; quarter-to-date) =

('Trade payables' / ['Cost of goods sold' + 'Purchase of property, plant and equipment']) * 90

**Please note:**

All positions in ' ' refer to the respective accounting position and therefore should be applied with the positive or negative sign used in the relevant accounting table.

**DSO** (days sales outstanding; quarter-to-date) =

('Trade receivables' / 'revenue') * 90
Infineon is a long-standing member of Europe's leading sustainability indices

Infineon’s most recent achievements

› Sep 2016: Infineon is listed in the STOXX® Global ESG Leaders Indices, which serves as an indicator of the quality of Infineon’s performance in the governance, social and environmental areas (ESG).

› Infineon was added to the FTSE4Good Index Series in 2001 and has been confirmed as a member since then.

› Sep 2016: Infineon is listed in the Sustainability Yearbook for the sixth consecutive year and, according to RobecoSAM, among the top 15% most sustainable companies worldwide.

› Dec 2015: In the Carbon Disclosure Project (CDP) climate change report, Infineon achieved a placing among the best companies in the Information Technology sector.

› Oct 2016: Infineon has been selected as a constituent of the Ethibel Sustainability Index (ESI) Excellence Europe.

› Jul 2016: Most recent review.
## Financial calendar

<table>
<thead>
<tr>
<th>Date</th>
<th>Location</th>
<th>Event</th>
</tr>
</thead>
<tbody>
<tr>
<td>02 Feb 2017*</td>
<td></td>
<td>Q1 FY17 Results</td>
</tr>
<tr>
<td>16 Feb 2017</td>
<td>Munich</td>
<td>Annual General Meeting</td>
</tr>
<tr>
<td>27 Feb – 02 Mar 2017</td>
<td>Barcelona</td>
<td>Mobile World Congress</td>
</tr>
<tr>
<td>04 May 2017*</td>
<td></td>
<td>Q2 FY17 Results</td>
</tr>
<tr>
<td>30 May 2017</td>
<td>Copenhagen</td>
<td>German Corporate Day by Danske Bank Markets</td>
</tr>
<tr>
<td>31 May – 01 Jun</td>
<td>New York</td>
<td>Bernstein Strategic Decision Conference</td>
</tr>
<tr>
<td>21 – 22 Jun 2017</td>
<td>Berlin</td>
<td>Dt. Bank German, Swiss &amp; Austrian Conference</td>
</tr>
<tr>
<td>01 Aug 2017*</td>
<td></td>
<td>Q3 FY17 Results</td>
</tr>
<tr>
<td>19 Sep 2017</td>
<td>Munich</td>
<td>Berenberg Bank and Goldman Sachs German Corporate Conference</td>
</tr>
<tr>
<td>20 Sep 2017</td>
<td>Munich</td>
<td>Baader Investment Conference</td>
</tr>
<tr>
<td>14 Nov 2017*</td>
<td>Munich</td>
<td>Q4 FY17 and FY 2017 Results</td>
</tr>
<tr>
<td>15 – 16 Nov 2017</td>
<td>Barcelona</td>
<td>Morgan Stanley TMT Conference</td>
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</tbody>
</table>

* preliminary
### Glossary

<table>
<thead>
<tr>
<th>Abbreviation</th>
<th>Description</th>
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<tbody>
<tr>
<td>ACC</td>
<td>adaptive cruise control</td>
</tr>
<tr>
<td>AD</td>
<td>automated driving</td>
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<tr>
<td>ADAS</td>
<td>advanced driver assistance system</td>
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<tr>
<td>AEB</td>
<td>automatic emergency braking</td>
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<tr>
<td>BoM</td>
<td>bill of material</td>
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<tr>
<td>EPS</td>
<td>electric power steering</td>
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<tr>
<td>EV</td>
<td>electric vehicle</td>
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<tr>
<td>FCW</td>
<td>forward collision warning</td>
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<tr>
<td>HEV</td>
<td>mild and full hybrid electric vehicle</td>
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<tr>
<td>ICE</td>
<td>internal combustion engine</td>
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<tr>
<td>micro-hybrid</td>
<td>vehicles using start-stop systems and limited recuperation</td>
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<tr>
<td>mild-hybrid</td>
<td>vehicles using start-stop systems, recuperation, DC-DC conversion, e-motor</td>
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<tr>
<td>PHEV</td>
<td>plug-in hybrid electric vehicle</td>
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<tr>
<td>SiC</td>
<td>silicon carbide</td>
</tr>
<tr>
<td>SiGe</td>
<td>silicon germanium</td>
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<tr>
<td>V2X</td>
<td>vehicle-to-everything communication</td>
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<tr>
<td>xEV</td>
<td>all degrees of vehicle electrification (EV, HEV, PHEV)</td>
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</tbody>
</table>
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